

ADIP Demodulator for MiniDisc

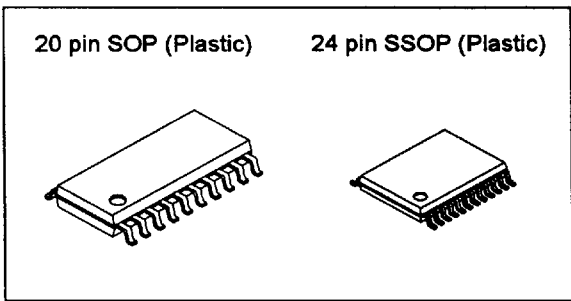
Description

The CXA1380M/N can be used to read the ADIP (Address In Pre-groove) signal stamped in MiniDiscs.

Features

- ADIP FM demodulator
- ADIP defect protection circuit
- ADIP data clock regeneration circuit
- Generate of FG (Frequency Generator) signal used to CLV (Constant Linea Velocity) servo control, rough mode and standard mode.

When used in conjunction with the CXA1381, CXD2525, and others, the CXA1380 can decode address data from wobbled pre-groove on recordable discs.



Applications

Reproducece the binary data from the ADIP signal in Mini Discs. The binary data is used for controlling motor and include address information.

Structure

Bipolar silicon monolithic IC

Absolute Maximum Ratings (Ta = 25°C)

• Supply voltage	V _{CC}	7	V
• Operating temperature	T _{opr}	-20 to +75	°C
• Storage temperature	T _{stg}	-65 to +150	°C
• Allowable power dissipation			
CXA1380M	P _D	700	mW
CXA1380N	P _D	620	mW

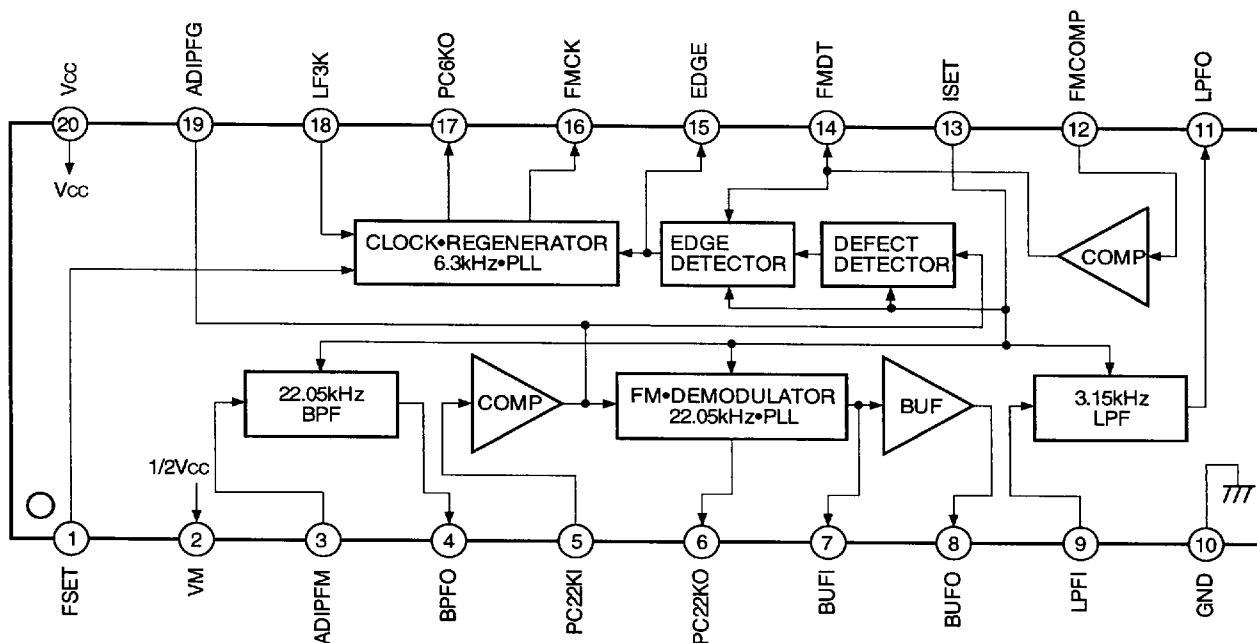
Operating Conditions

• Supply voltage	V _{CC}	3.6 to 5	V
------------------	-----------------	----------	---

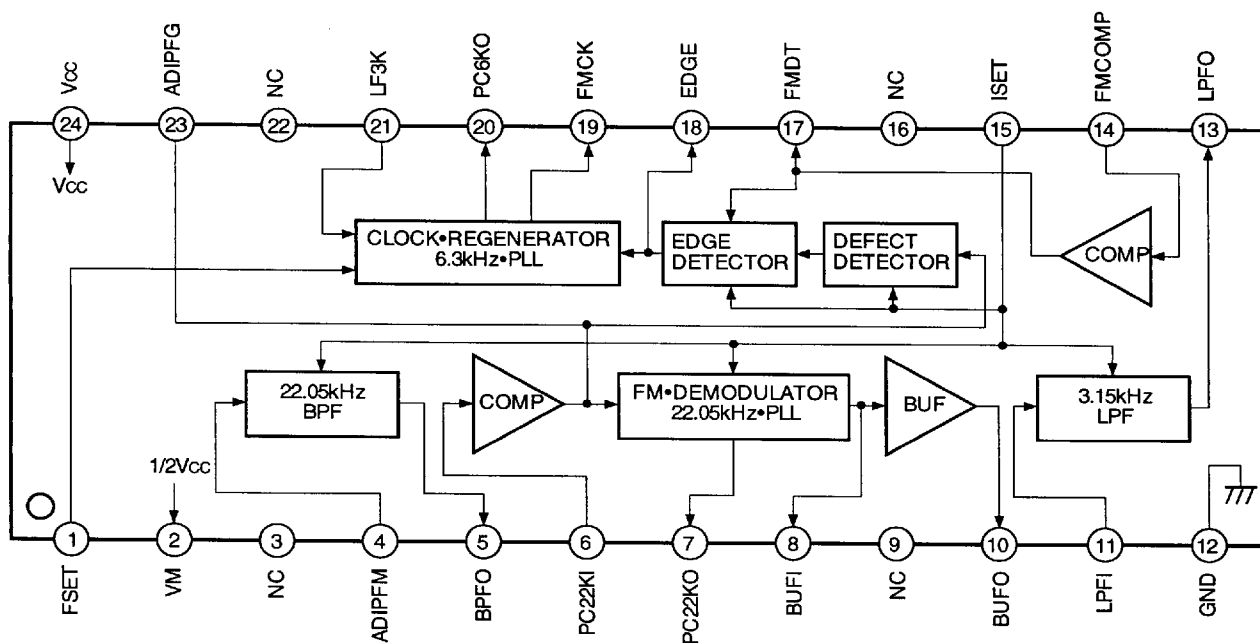
Sony reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

Block Diagram and Pin Configuration

CXA1380M



CXA1380N



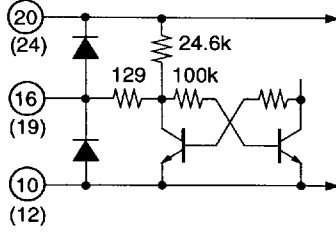
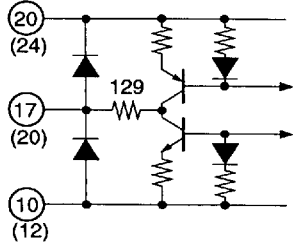
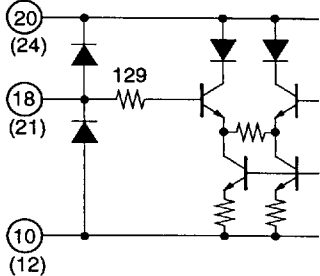
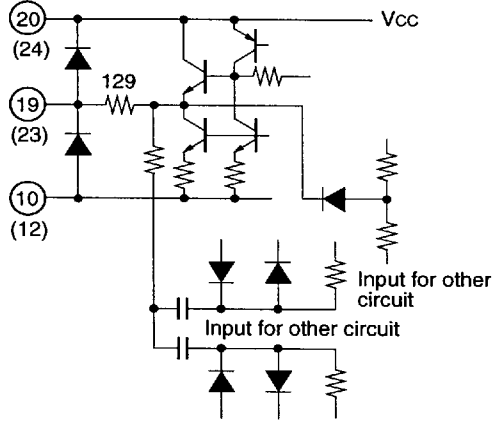
Pin Description

The pin numbers are for the CXA1380M. The pin numbers given in parentheses are for the CXA1380N.

Pin No.	Symbol	Typical voltage	Equivalent Circuit	Description
1 (1)	FSET	720mV		Setting a free running frequency of VCO used for ADIP bit clock regenerator.
2 (2)	VM	2.5V		1/2 Vcc voltage output. Internal circuit bias voltage.
(3)	NC	OPEN		No connected.
3 (4)	ADIP FM	450mVp-p		ADIP FM signal input.
4 (5)	BPFO	1Vp-p +2.5V		Band-pass filter output.
5 (6)	PC22KI	1Vp-p +2.5V		Phase comparator input for FM demodulation. Connecting to BPFO (Pin 4 (5)) through the capacitor.

Pin No.	Symbol	Typical voltage	Equivalent Circuit	Description
6 (7)	PC22KO	Digital output		Phase comparator output for FM demodulation.
7 (8)	BUFI	0.8Vp-p +2.5V		PLL feedback for FM demodulation. Signal comes from PC22KO (Pin 6 (7)) through PLL's loop filter.
(9)	NC	OPEN		No connected.
8 (10)	BUFO	0.8Vp-p +2.5V		FM demodulation signal output.
9 (11)	LPFI	0.8Vp-p +2.5V		Low-pass filter input. Connecting to BUFO (Pin 8 (10)) through the capacitor.
10 (12)	GND	0V		GND.
11 (13)	LPFO	0.15Vp-p +2.5V		Low-pass filter output.

Pin No.	Symbol	Typical voltage	Equivalent Circuit	Description
12 (14)	FM COMP	0.15Vp-p +2.5V		ADIP data comparator input. Connecting to LPFO (Pin 11 (13)) through the capacitor.
13 (15)	ISET	720mV		Setting the constants below. <ul style="list-style-type: none"> • Band-pass filter f_o • Low-pass filter f_c • Free running frequency of VCO used for FM demodulation. • Edge pulse width • Defect pulse width
(16)	NC	OPEN		No connected.
14 (17)	FM DT	Digital output		ADIP data output.
15 (18)	EDGE	Digital output		Output for Gather edge used for ADIP data signal.

Pin No.	Symbol	Typical voltage	Equivalent Circuit	Description
16 (19)	FMCK	Digital output		ADIP bit clock output.
17 (20)	PC6KO	Digital output		Phase comparator output for ADIP bit clock regenerator.
18 (21)	LF3K	0.2Vp-p +2.5V		PLL feedback for ADIP bit clock regenerator. Signal comes from PC6KO (Pin 17 (20)) through PLL's loop filter).
(22)	NC	OPEN		No connected.
19 (23)	ADIPFG	Digital output		ADIP FM binary data output.
20 (24)	Vcc	5V		Power supply.

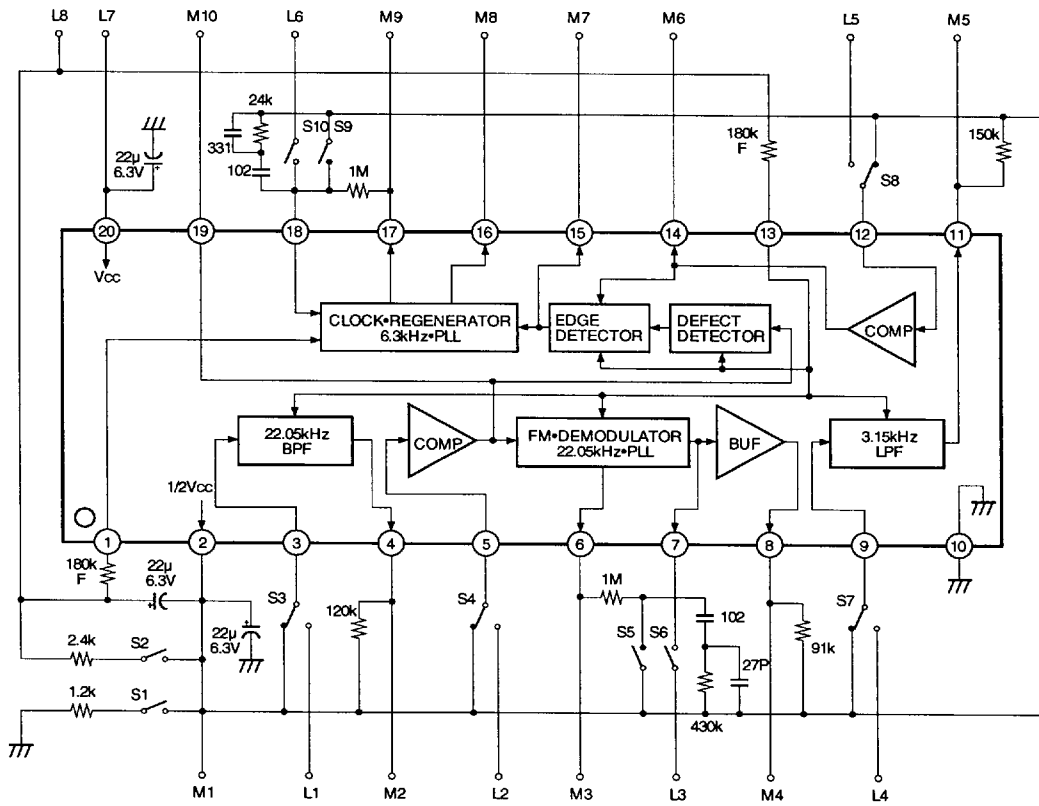
Electrical Characteristics (V_{CC} = 5V, T_a = 25°C)

No.	Item	Symbol	Switch conditions O: ON										Input			Output	Limit				
			S1	S2	S3	S4	S5	S6	S7	S8	S9	S10	Supply	Input A	Input B		Min.	Typ.	Max.	Unit	
1	Current consumption	I _{CC}											L7			L7	No input	3.5	6	9	mA
2	Output voltage	V _{MO}											↓	↓		M1	No load	2.45	2.5	2.55	V
3	Output current 1	I _{M1}											↓	↓		M1	SORCE Down 50mV for V _{MO}	2	4.5		mA
4	Output current 2	I _{M2}											↓	↓		M1	SINK Up 50mV for V _{MO}	1	3		mA
5	Voltage gain	G _{APF}											↓	L1		M2	I/O gain	6	8.5	11	dB
6	Frequency response 1	F _{APF1}											↓	L1	f = 22.05kHz, SINE 0.7V _{p-p} +2.5V	M2	I/O gain - GBPF	-10	-6.3	-2.5	dB
7	Frequency response 2	F _{APF2}											↓	L1	f = 16kHz, SINE 0.7V _{p-p} +2.5V	M2	I/O gain - GBPF	-11	-6.7	-3	dB
8	Output swing	V _{APFO}											↓	L1	f = 30kHz, SINE 0.7V _{p-p} +2.5V	M2	THD 5%	3.2	3.4		V _{p-p}
9	Operating input voltage	V _{FGIN}											↓	L2	f = 22.05kHz, SINE offset = V _{MO}	M10	Operating input voltage range	50			mV _{p-p}
10	Output voltage 1	V _{FEOH}											↓	L2	2.3V	M10		4	4.25		V
11	Output voltage 2	V _{FEOH}											↓	L2	2.7V	M10			300	600	mV
12	Free-running frequency	F _{DM00}											↓	L2	2.7V	M3		18	22	25	kHz
13	Frequency alteration 1	F _{DM01}											↓	L2	2.7V	M3	Variation for F _{DM00}	25	30	35	%
14	Frequency alteration 2	F _{DM02}											↓	L2	2.7V	M3	Variation for F _{DM00}	-36	-32	-26	%
15	Voltage gain	G _{BUF}											↓	L3	f = 3.15kHz, SINE 0.5V _{p-p} +2.5V	M4	Output/Input	0.944	1	1.059	
16	Output swing	V _{BUFO}											↓	L3	f = 3.15kHz, SINE offset = V _{MO}	M4	THD 1%	3.4	3.6		V _{p-p}

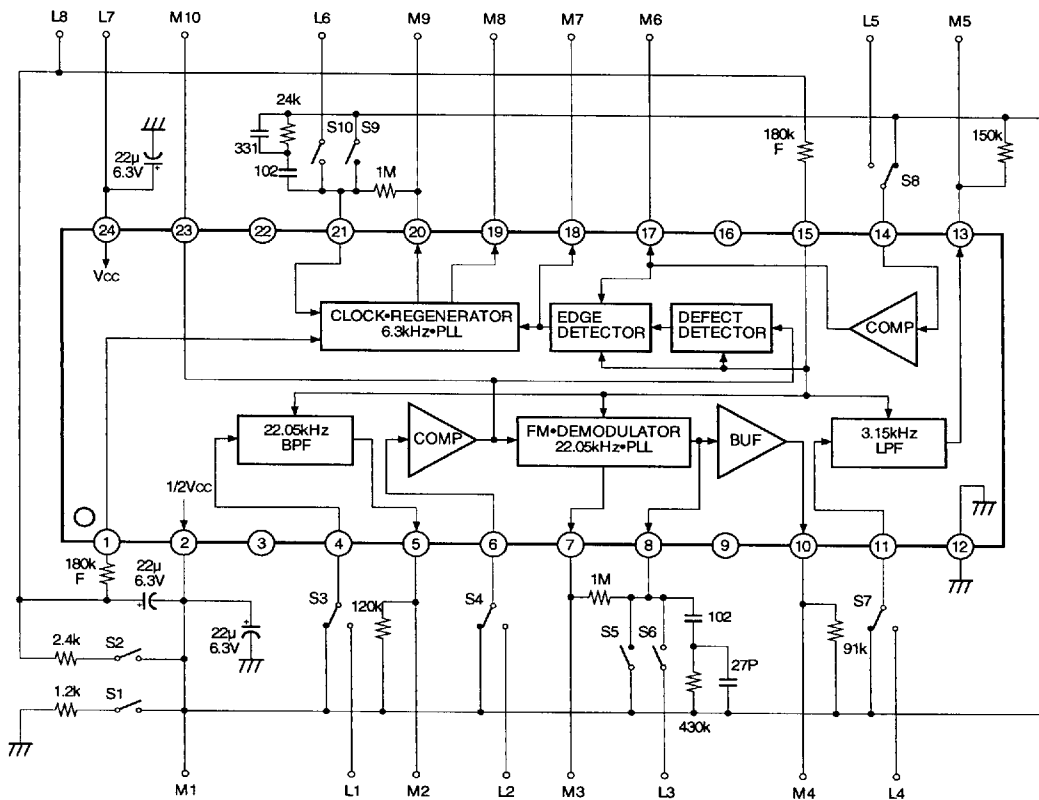
No.	Item	Symbol	Switch conditions										Input			Output	Limit			
			S1	S2	S3	S4	S5	S6	S7	S8	S9	S10	Supply	Input A	Input B		Min.	Typ.	Max.	Item
17	Voltage gain	GLPF											L7	L4		M5	-2.5	-0.4	1.0	dB
															L8	f = 500kHz, SINE 0.5Vp-p±2.5V				
18	Frequency response	FLPF											↓	L4		M5	-6	-2.5	0	dB
															L4	f = 3.8kHz, SINE 0.5Vp-p±2.5V				
19	Output swing	VLFP0											↓	L4		M5	2.7	2.9		Vp-p
															L4	f = 3.15kHz, SINE offset = VMO				
20	Operating input voltage	VDIN										↓	L5		M6	40			mVp-p	
															L5	f = 3.15kHz, SINE offset = VMO				
21	Output voltage 1	VDOH										↓	L5		M6	4	4.25		V	
															L5	2.3V				
22	Output voltage 2	VDOL										↓	L5		M6	10	10	200	mV	
															L5	2.7V				
23	Edge width-1	TEDGE1										↓	L2		M7	60	81	110	µs	
															L5	f = 22kHz, SINE 0.7Vp-p±2.5V				
24	Edge width-2	TEDGE2										↓	L2		M7	60	81	110	µs	
															L5	f = 22kHz, SINE 0.7Vp-p±2.5V				
25	Carrier frequency	FCAR										↓	L2		M7	15	22.05		kHz	
															L5	f = 3.15kHz, SINE 0.5Vp-p±2.5V				
26	Free-running frequency	FCLK0										↓	L5		M8	5.7	6.3	6.8	kHz	
															L6	VMO				
27	Frequency alteration 1	FCLK1										↓	L5		M8	28	34	38	%	
															L6	VMO+0.5V				
28	Frequency alteration 2	FCLK2										↓	L5		M8	-38	-34	-28	%	
															L6	VMO-0.5V				

Measurement Circuit

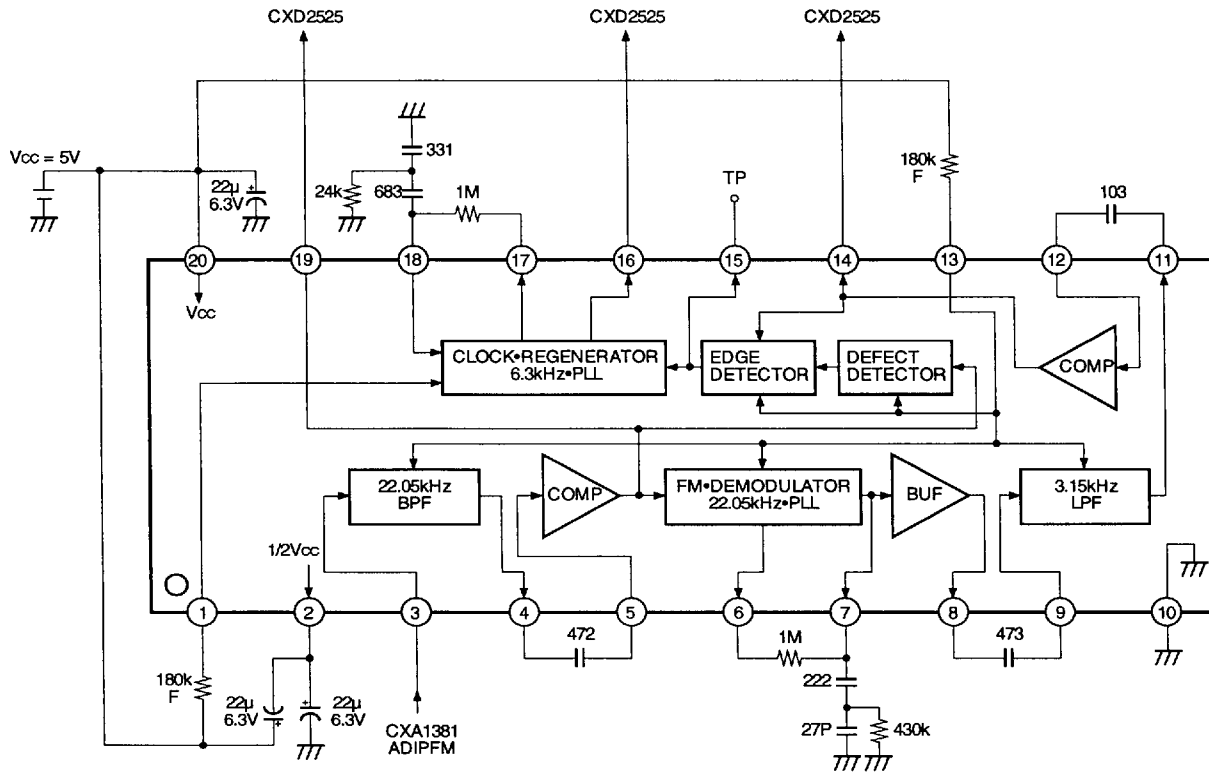
CXA1380M



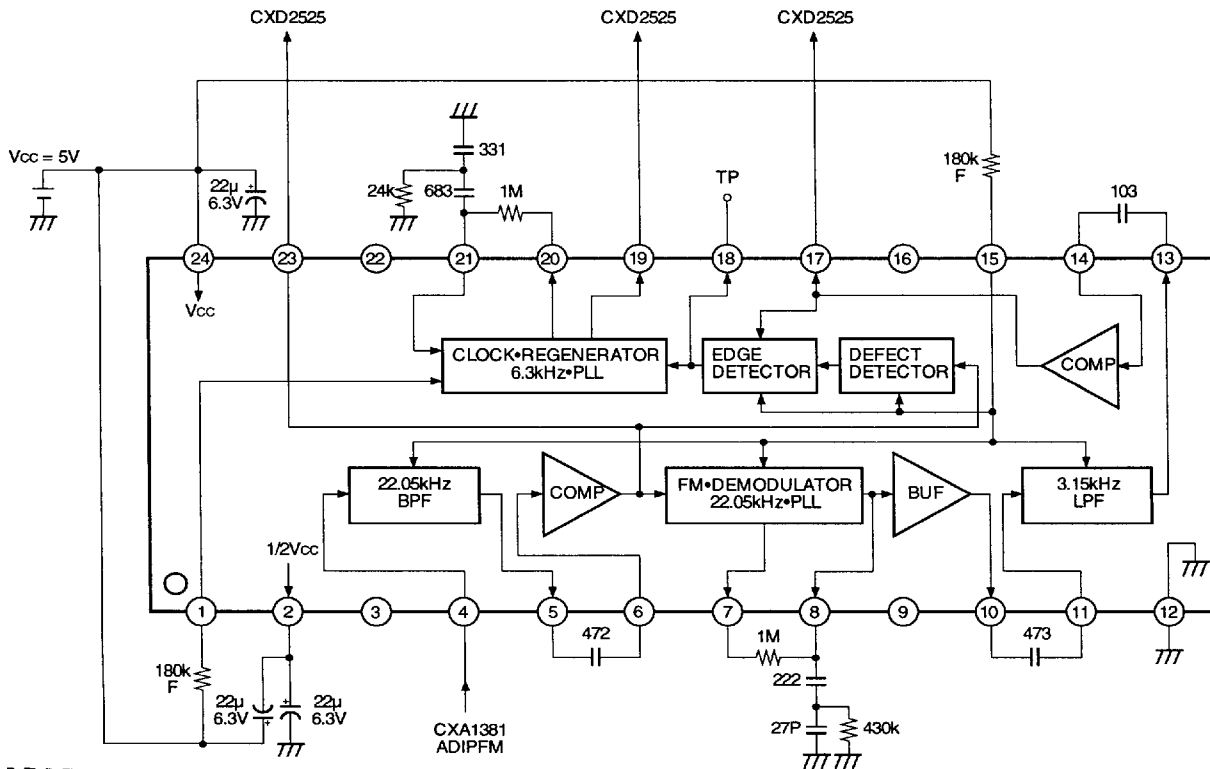
CXA1380N



Application Circuit
CXA1380M



CXA1380N



8382383 0009207 252

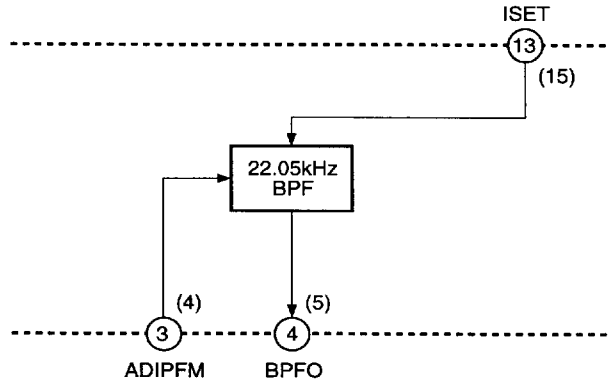
Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

10

Description of Functions

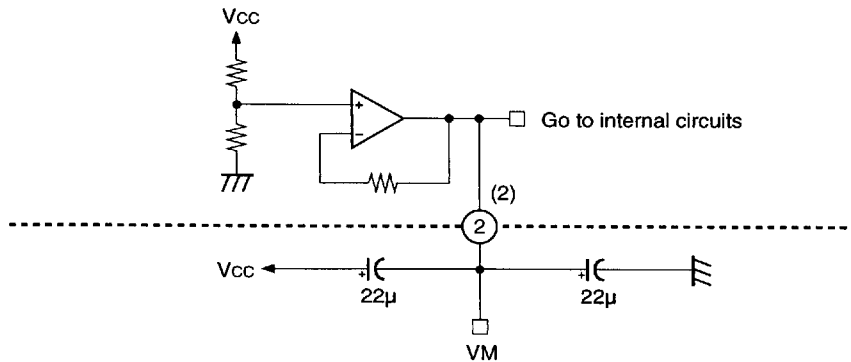
The following explanations are for the CXA1380M as representation. The only difference with the CXA1380N concerns the pin numbers; the operation of the internal circuits for each is identical.

1. Band-pass filter



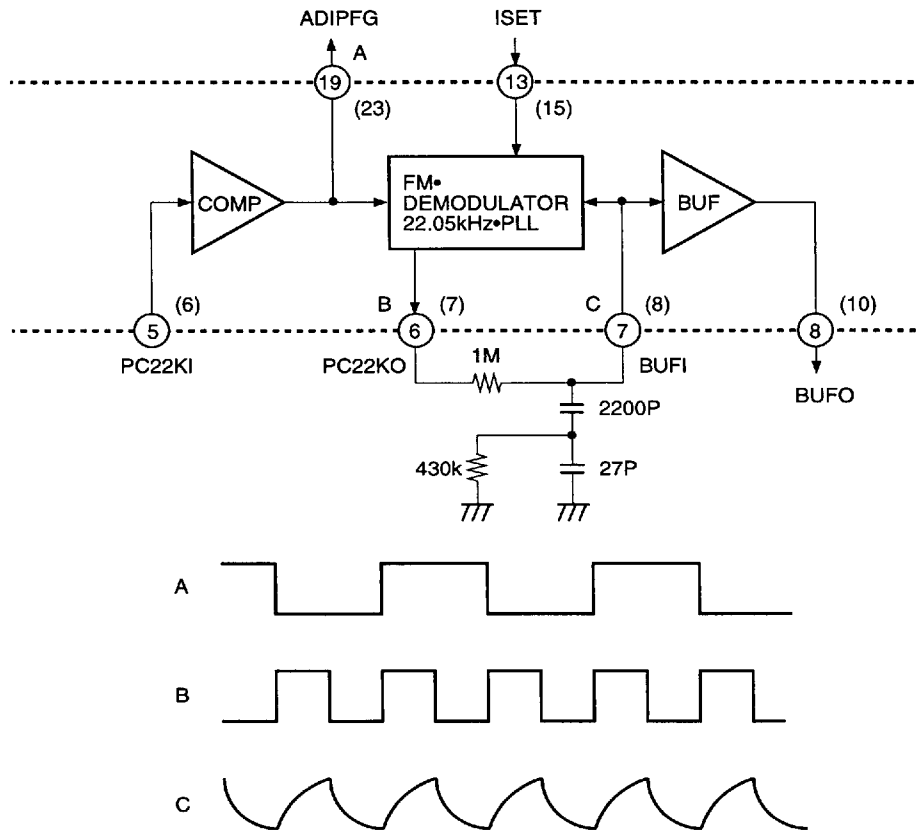
Band-pass filter (BPF) is eliminating the noises from ADIP signal. Signal comes from CXA1381-RF matrix amplifier with a 22.05 ± 1 kHz FM signal.

2. Center voltage generation circuit



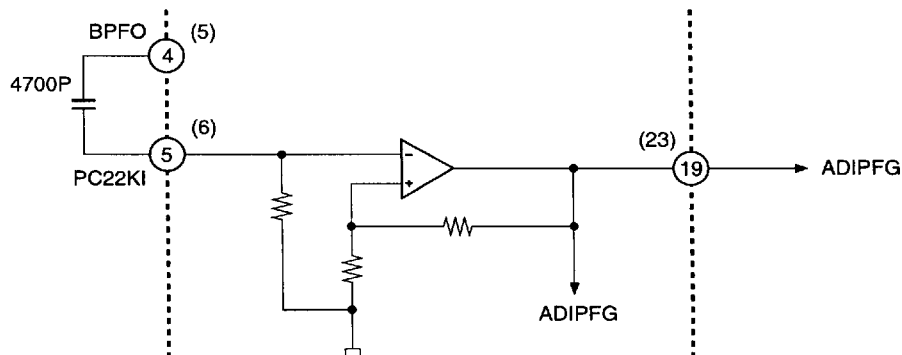
This circuit is generating a half voltage of supply voltage, and take of operating reference to internal circuits. Motors or actuators can not be connected because the maximum output currents are +2mA and -1mA. Note that an electrolytic capacitor should be connected as shown in the diagram to reduce the noises and maintaining a normally operation.

3. FM demodulator



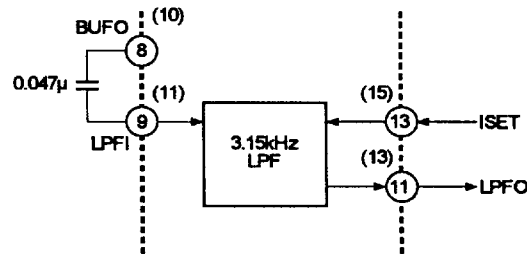
The circuit is extracting the bi-phase data from 22.05±1kHz FM modulated signal (ADIPFM) in applied to PLL, that is an explanation next. PC22KI is input of ADIPFM signal. It's an analog signal, can't matching the digital circuits, because passing through the BPF. ADIPFM signal is transformed to binary value by the COMP, and bring to ADIPFG output. PC22KO is output of the compared signal of ADIPFG signal and internal VCO signal. BUFI is input of the PC22KO signal through the loop filter (LPF), and then complete the PLL circuit is controlling the oscillation frequency of internal VCO. In addition, the buffer is reducing the impedance of loop filter and outputting to BUFO.

4. CLV rough servo FG



The spindle motor is controlled by servo control of two states. This one is a rough servo which pull the revolutions in the captor range of motor's PLL circuit with ADIPFG signal. Another one is a standard (Phase lock loop) servo which adjust the revolutions in data ADICK with FMCK signal. This circuit is producing the digital signal in use the CLV rough servo. The digital signal is a FG signal and made by 22.05±1kHz ADIPFM. The FG signal is made by comparator with hysteresis, and outputting to ADIPFG.

5. Low-pass filter

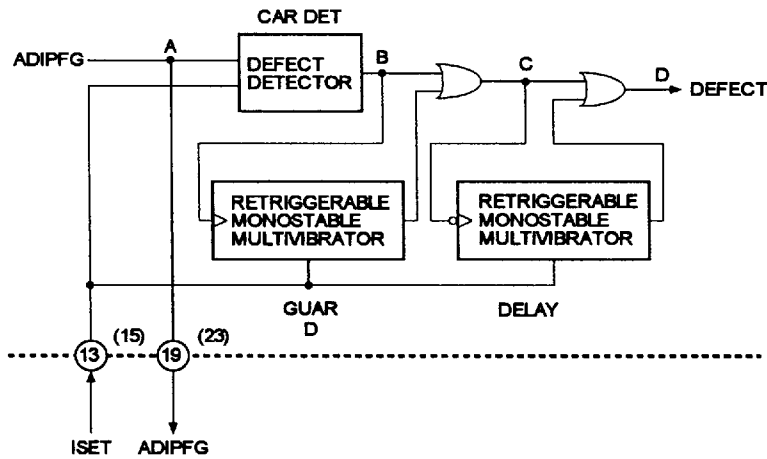


This circuit eliminates the carrier component (22.05kHz) from the BPFO output signal (It has components of carrier and bi-phase data), and produce the bi-phase data.

The filter is set to cut off frequency of 5kHz.

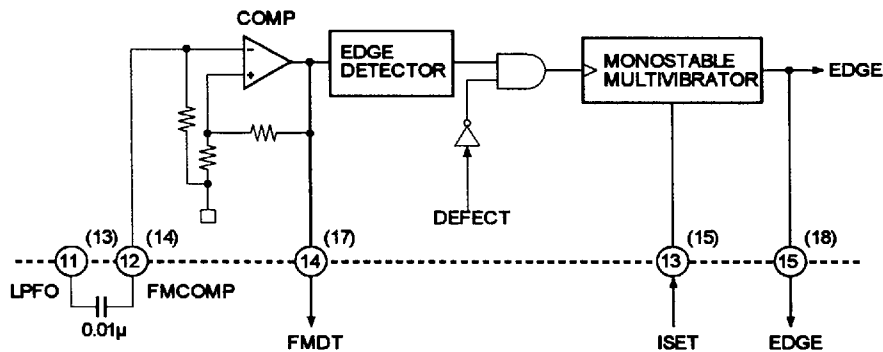
The input signal of LPFI needs the capacitor.

6. Defect detection



This circuit detects defects in ADIP.

7. Edge detection

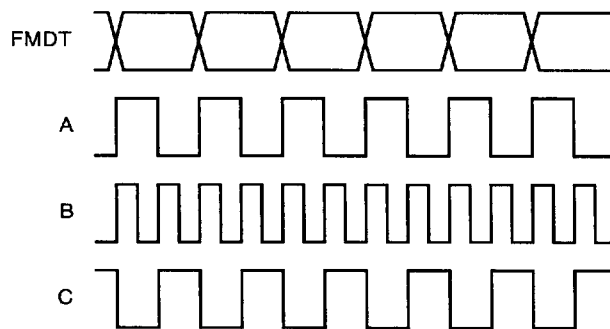
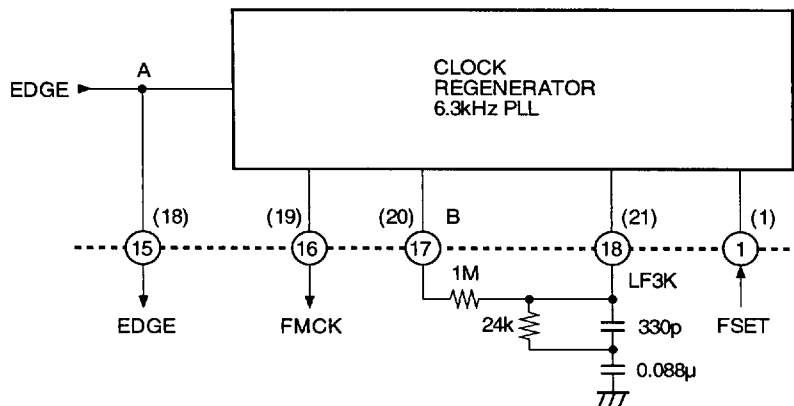


If you want to extract the bit clock included the bi-phase data. You must get the edge timing from the bi-phase data with EDGE DETECTOR. After that, MONOSTABLE MULTIVIBRATOR is triggered by edge signal and marking a 78µs pulse.

However, when DEFECT is high, the pulse is stopped.

FMDT output signal is a bi-phase data processed binary value.

8. Clock regenerator



This circuit regenerates the bit clock from edges included bi-phase data. 6.3kHz PLL is locked to the edges timing, and create the double frequency, and the signal is outputed to the FMCK.

Notes on Operation

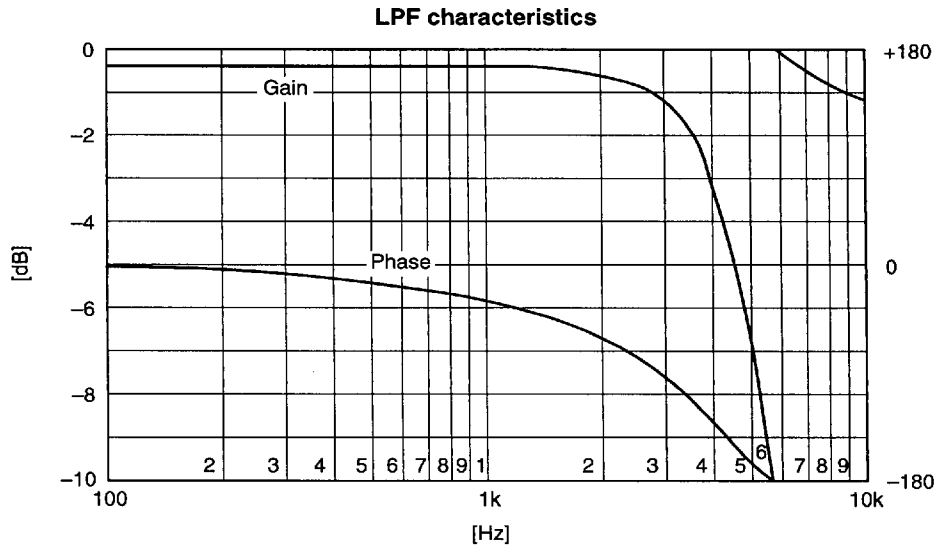
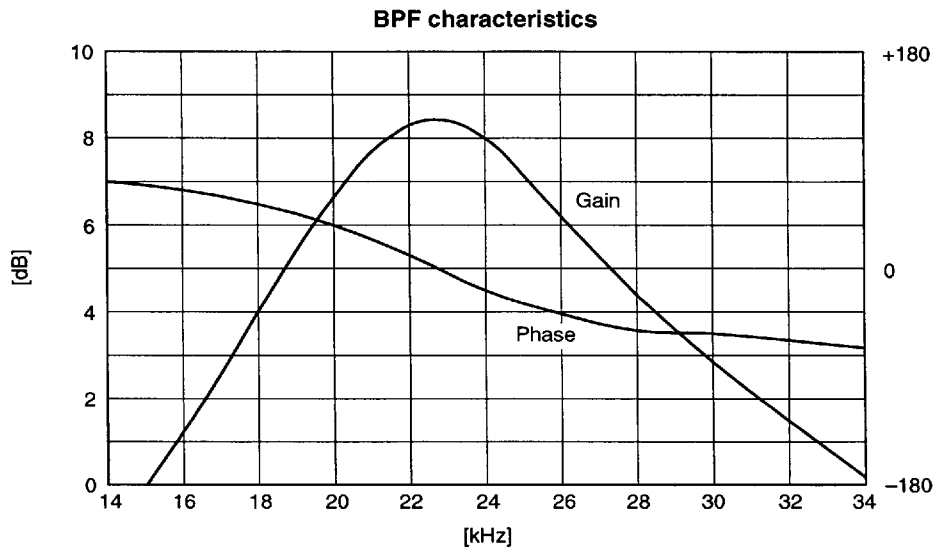
CXA1380M

- When using FMDT (Pin 14), EDGE (Pin 15), FMCK (Pin 16), and ADIPFG (Pin 19), they should be received using Schmitt triggers. However buffers are not needed because the CXD2525 has built-in Schmitt triggers.
- Do not use shielded wire or coaxial cable to carry the signals because each output pin has little drive capability. Connect the output pins to other ICs on the PCB by the shortest route possible.

CXA1380M

- When using FMDT (Pin 17), EDGE (Pin 18), FMCK (Pin 19), and ADIPFG (Pin 23), they should be received using Schmitt triggers. However buffers are not needed because the CXD2525 has built-in Schmitt triggers.
- Do not use shielded wire or coaxial cable to carry the signals because each output pin has little drive capability. Connect the output pins to other ICs on the PCB by the shortest route possible.
- Pins 3, 9, 16, and 22 are not connected internally. The anti-noise performance of the IC are improved when these pins are connected to GND.

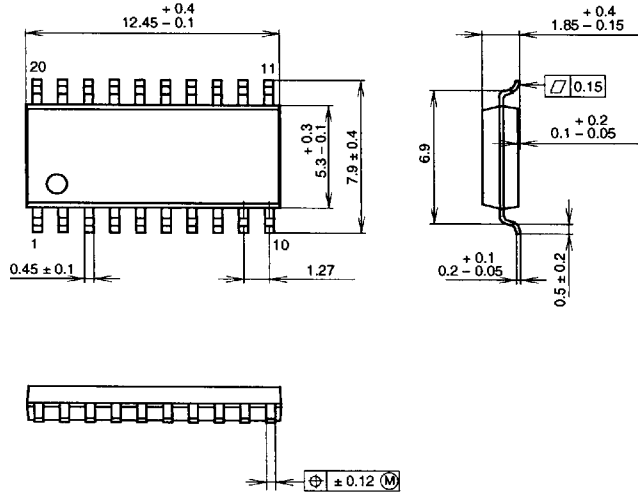
Example of Representative Characteristics



Package Outline Unit: mm

CXA1380M

20PIN SOP (PLASTIC) 300mil



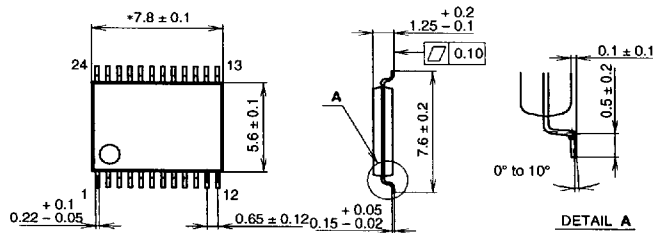
PACKAGE STRUCTURE

SONY CODE	SOP-20P-L01
EIAJ CODE	*SOP020-P-0300-A
JEDEC CODE	—

PACKAGE MATERIAL	EPOXY / PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE WEIGHT	0.3g

CXA1380N

24PIN SSOP (PLASTIC) 275mil



NOTE : *NOT INCLUDE MOLD FINIS.

PACKAGE STRUCTURE

SONY CODE	SSOP-24P-L01
EIAJ CODE	A SIMILAR TO SSOP024-P-0300
JEDEC CODE	—

PACKAGE MATERIAL	EPOXY / PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42 ALLOY
PACKAGE WEIGHT	—